Electronic Patent Application Fee Transmittal								
Application Number:	10	10815654						
Filing Date:	02-	02-Apr-2004						
Title of Invention:	Semiconductor device having pair of flexible substrates							
First Named Inventor/Applicant Name:	Shunpei Yamazaki							
Filer:	Eric J. Robinson/Jennifer Rosenfeld							
Attorney Docket Number:	0756-7279							
Filed as Large Entity								
Utility under 35 USC 111(a) Filing Fees								
Description		Fee Code	Quantity	Amount	Sub-Total in USD(\$)			
Basic Filing:								
Pages:								
Claims:								
Miscellaneous-Filing:								
Petition:								
Patent-Appeals-and-Interference:								
Notice of appeal		1401	1	540	540			
Post-Allowance-and-Post-Issuance:								
Fytension-of-Time:								

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
	Total in USD (\$)			540